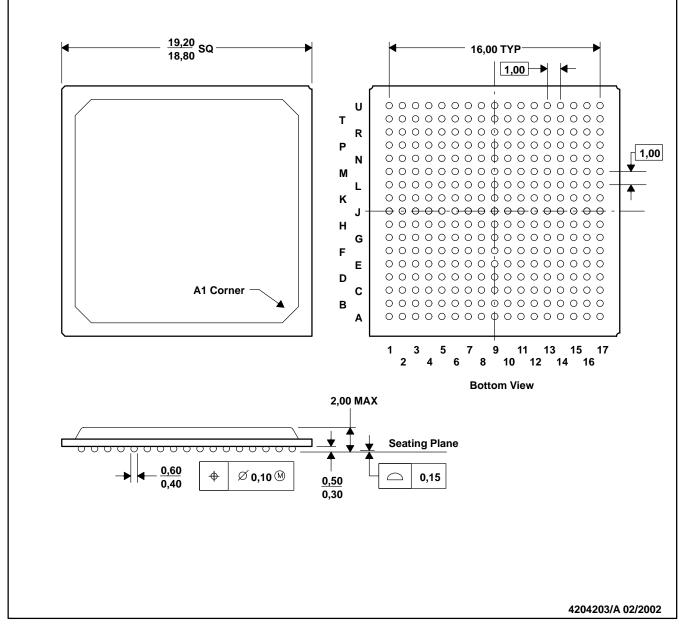
MECHANICAL DATA

MPBG233 - FEBRUARY 2002

PLASTIC BALL GRID ARRAY

GPV (S-PBGA-N289)



NOTES: A. All linear dimensions are in inches (millimeters). B. This drawing is subject to change without notice.



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Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

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